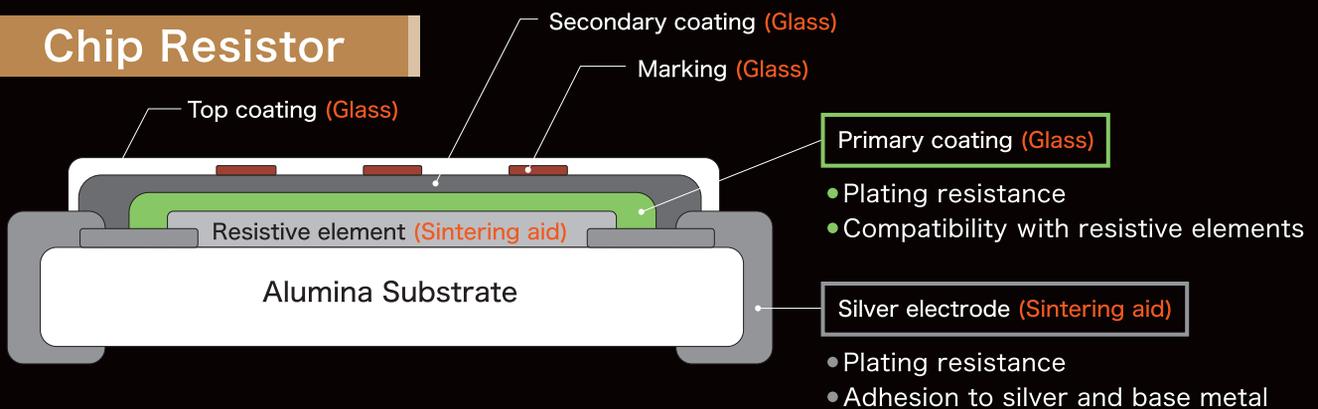


Lead-free glass powder for electronic components

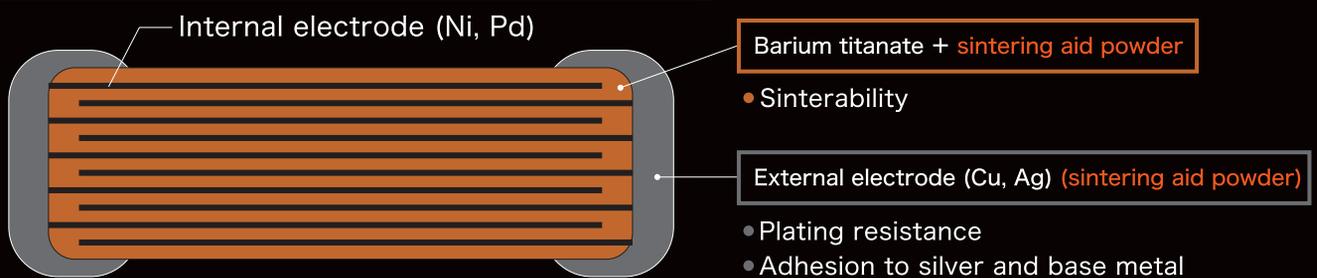


Support electronic component industry
OKUNO's glass powder supports various industry

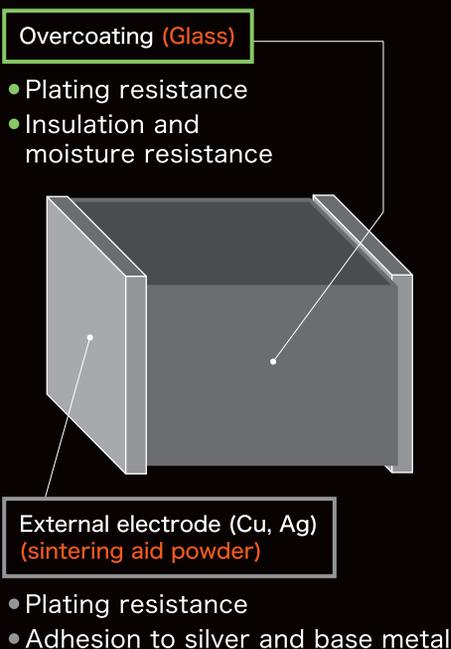
Chip Resistor



Multilayer Ceramic Capacitors



Chip thermistor, Inductors and others



Lead-free glass powder for electronic components

Type	Product	Coefficient of thermal expansion ($\times 10^7/^\circ\text{C}$)	Temperature of softening ($^\circ\text{C}$)	Insulation resistance value (Ω)
Bi	GF3410	108	414	5.0×10^9
	GF3520	77	518	1.4×10^{13}
	GF3550	84	560	6.4×10^8
	GF3580	68	578	7.1×10^{12}
Zn	GF4550	80	575	7.7×10^9
	GF4610	60	630	4.8×10^{11}
	GF4630	43	631	2.0×10^{12}
Si	GF5600	75	600	9.4×10^9
	GF5770	64	740	2.8×10^{11}
	GF5780	56	780	1.9×10^{12}